



GE Energy

Functional Testing Specification

*Parts & Repair Operations
Louisville, KY*

LOU-GEF-IC600xx901-A

Test Procedure for Remote I/O Transmitter Card

DOCUMENT REVISION STATUS: Determined by the last entry in the "REV" and "DATE" column

REV.	DESCRIPTION	SIGNATURE	REV. DATE
A	Initial release	Cristyn Edlin	10/06/08
B			
C			

© COPYRIGHT GENERAL ELECTRIC COMPANY

Hard copies are uncontrolled and are for reference only.

PROPRIETARY INFORMATION – THIS DOCUMENT CONTAINS PROPRIETARY INFORMATION OF GENERAL ELECTRIC COMPANY AND MAY NOT BE USED OR DISCLOSED TO OTHERS, EXCEPT WITH THE WRITTEN PERMISSION OF GENERAL ELECTRIC COMPANY.

PREPARED BY Cristyn Edlin	REVIEWED BY	REVIEWED BY	QUALITY APPROVAL Charlie Wade
DATE 10/06/08	DATE	DATE	DATE 10/6/2008

LOU-GEF-IC600xx901 REV. A	g GE Energy <i>Parts & Repair Operations</i> <i>Louisville, KY</i>	Page 2 of 3
------------------------------	--	-------------

1. SCOPE

1.1 This is a functional testing procedure for a Series Six Remote I/O Driver Card.

2. STANDARDS OF QUALITY

2.1 Refer to the current revision of the IPC-A-610 standard for workmanship standards.

3. APPLICABLE DOCUMENTS

3.1 The following document(s) shall form part of this specification to the extent specified herein. Unless otherwise indicated, the latest issue shall apply.

3.1.1

4. ENGINEERING REQUIREMENTS

4.1 Equipment Cleaning

4.1.1 Equipment should be clean and free of debris prior to applying power unless performing an initial check. Refer to the local documented procedures for cleaning guidelines.

4.2 Equipment Inspection

4.2.1 Equipment should be visually inspected for any defects prior to applying power. This inspection should include the following as a minimum:

4.2.1.1 Wires: broken, cracked, or loosely connected

4.2.1.2 Terminal strips / connectors: broken or cracked

4.2.1.3 Components: visually damaged

4.2.1.4 Capacitors: bloated or leaking

4.2.1.5 Solder joints: damaged or cold


4.2.1.6 Circuit board: burned or de-laminated

4.2.1.7 Printed wire runs / Traces: burned or damaged

5. EQUIPMENT REQUIRED

5.1 The following equipment is required to perform the process requirements. Equipment may be substituted provided that all accuracy's and test ratios are equivalent or better.

Qty	Reference #	Description
1		CPU-3 Local Rack
1		Series Six Card Extractor

LOU-GEF-IC600xx901 REV. A	 GE Energy <i>Parts & Repair Operations</i> <i>Louisville, KY</i>	Page 3 of 3
------------------------------	--	-------------

6. SETUP

- 6.1 Ensure that the jumper settings of the customer card are as follows. 1-2, 6-7, 9-10, 12-13, 15-16, 18-19, 21-22, 24-25, 26-27, 30-50, 33-51, 47-49, 39-40, 37-35, 43-56 and 45-46.
- 6.2 Turn off power to the rack. The rack you should be using is the local CPU-3 rack just right of the OIT panel.
- 6.3 Disconnect the data cable from the front edge of the shop card.
- 6.4 Extract the shop card from slot 3.
- 6.5 Insert the customer card into slot 3.
- 6.6 Connect the data cable to the front edge of the customer card.

7. TEST PROCESS

- 7.1 Turn on power to the rack.
- 7.2 Press the master reset button on the center control panel of the CPU Rack System.
- 7.3 Let card burn in for a minimum of 1 hour or until a fault occurs.
- 7.4 Turn off power to the rack.
- 7.5 Disconnect the data cable from the front edge of the customer card.
- 7.6 Extract the customer card from slot 3.
- 7.7 Insert the shop card into slot 3.
- 7.8 Connect the data cable to the front edge of the shop card.
- 7.9 Turn on power to the rack.
- 7.10 Press the master reset button on the center control panel of the CPU Rack System.
- 7.11 *Test complete. *

8. NOTES

9. ATTACHMENTS